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Electronic Version v1.1

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Title of Invention	SNAP-IN HEAT SINK FOR SEMICONDUCTOR MOUNTING		
Application Number :			
Date:			
First Named Applica	Dennis R. Sigl		
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Documents being submitted: Files us-assignment submit-usassn.xml us-assignment.xsl us-assignment.dtd ass1.tif ass2.tif us-request submit-usrequ.xml us-request.dtd us-request.xsl us-fee-sheet submit-usfees.xml us-fee-sheet.xsl us-fee-sheet.dtd Dec1.tif us-declaration Dec2.tif us-declaration patapp-trans.xml application-body us-application-body.xsl application-body.dtd wipo.ent mathml2.dtd mathml2-gname-1.mod isoamsa.ent isoamsb.ent isoamsc.ent isoamsn.ent isoamso.ent isoamsr.ent isogrk3.ent isomfrk.ent isomopf.ent isomscr.ent isotech.ent isobox.ent isocyr1.ent isocyr2.ent isodia.ent isolat1.ent isolat2.ent isonum.ent isopub.ent mmlextra.ent mmlalias.ent soextblx.dtd Fig1.tif Fig2.tif Fig3.tif Fig4.tif Fig5.tif Fig67.tif Fig8.tif Comments